



GS2AN THRU GS2MN

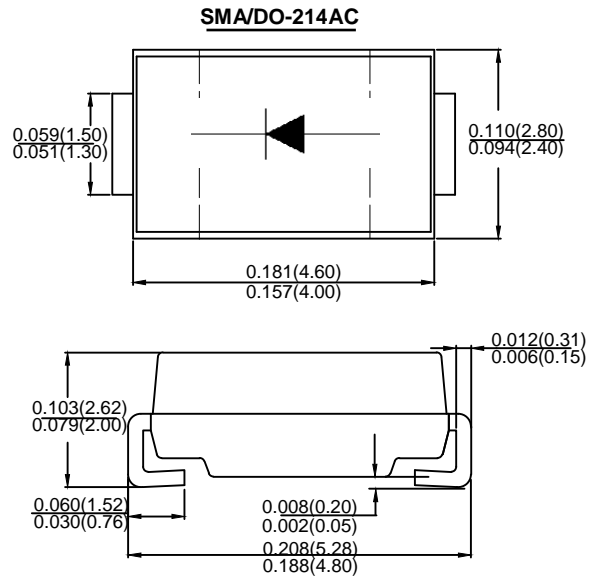
2.0AMP SURFACE MOUNT GLASS RECOVERY RECTIFIER

Features

- For surface mounted application
- Low forward voltage drop
- High current capability
- High reliability
- Plastic Case Material has UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: Molded plastic SMA
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Marking: Type Number



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load

For capacitive load derate current by 20%

Type Number	SYMBOL	GS2AN	GS2BN	GS2DN	GS2GN	GS2JN	GS2KN	GS2MN	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Average Rectified Output Current @T _L =100℃	I _{F(AV)}	2.0							A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	50							A
Rating for fusing (t<8.3ms)	I ² t	10.38							A ² s
Forward Voltage @IF=2.0A	V _{FM}	1.1							V
Peak Reverse Current @T _A =25℃	I _R	5.0							uA
At Rated DC Blocking Voltage @T _A =125℃		200							
Typical Junction Capacitance (Note 1)	C _J	12							pF
Typical Thermal Resistance Junction to Ambient(Note 2)	R _{θ JA}	50							℃/W
Operating Temperature Range	T _J	-55 to+150							℃
Storage Temperature Range	T _{STG}	-55 to +150							℃

Note: 1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C

2. Device mounted on FR-4 substrate, 1"×1", 2oz, single-sided, PC boards with 0.1"×0.15" copper pad.



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FIG.1-TYPICAL FORWARD CURRENT
DERATING CURVE

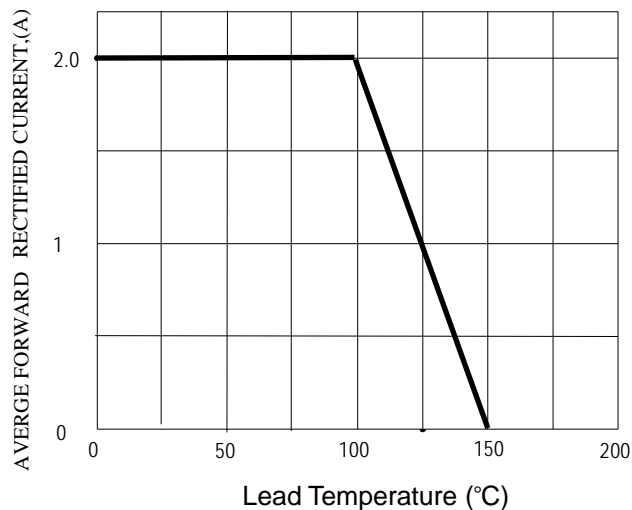


FIG.2-TYPICAL INSTANTANEOUS FORWARD
CHARACTERISTICS

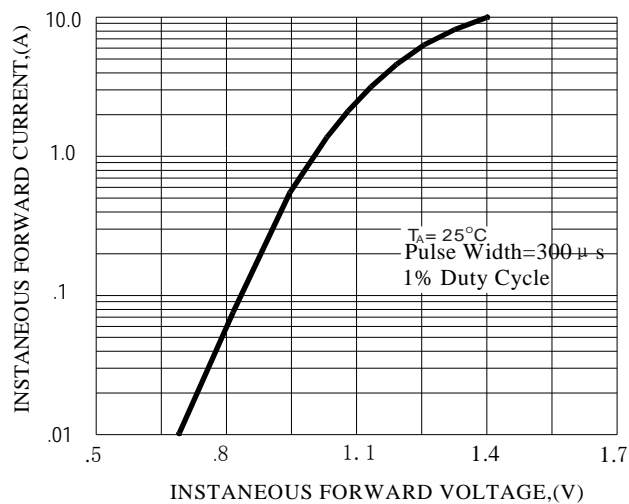


FIG.3-MAXIMUM NON-REPETITIVE
FORWARD SURGE CURRENT

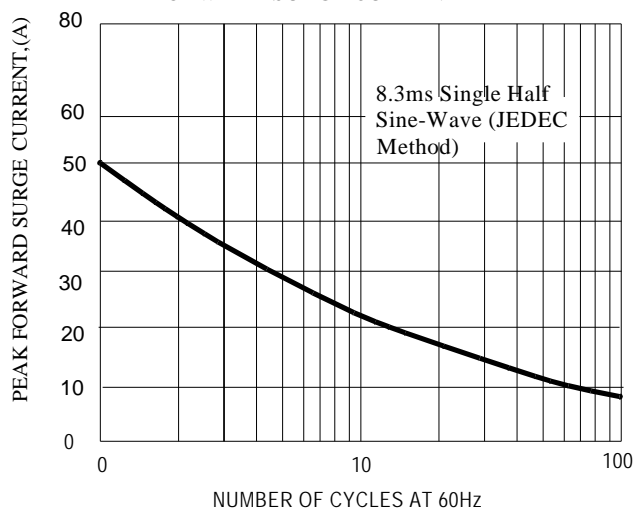
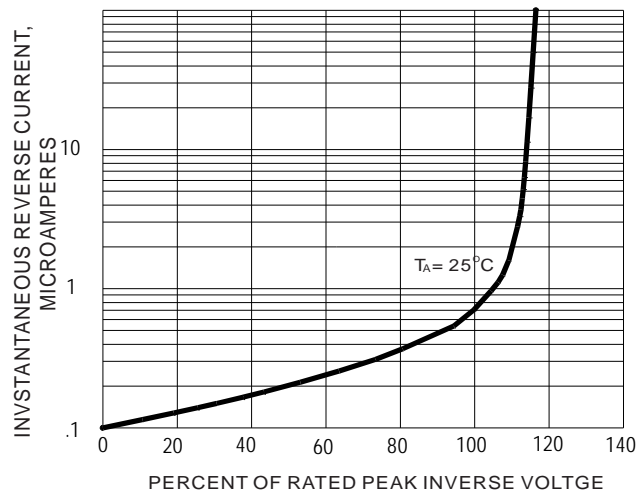
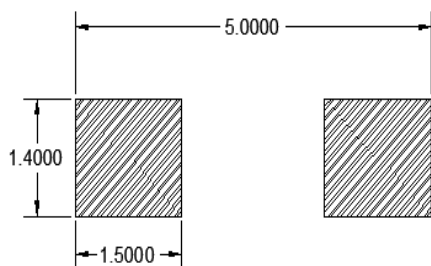


FIG.4-TYPICAL REVERSE
CHARACTERISTICS



SMA PAD LAYOUT





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